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(54) **ELECTRONIC CIRCUIT BOARD AND  
ELECTRONIC DEVICE**

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**ABSTRACT**

An electronic circuit board includes first and second circuit boards, and a relay board sandwiched between the first and second circuit boards and electrically connecting the first and second circuit boards to each other. Reinforcement between the first circuit board and the relay board is made by using an electronic component for reinforcement provided at an internal corner portion between the first circuit board and the relay board among electronic components mounted on the first circuit board.

